

# T7987A, JT7987AY-CS

## T7987A, JT7987AY-CS SINGLE-CHIP CMOS LSI FOR LCD CALCULATORS

The T7987A, JT7987AY-CS is single-chip microcomputer for 10-digit + 2-digit scientific calculation.

T7987A, JT7987AY-CS is the complete single-chip CMOS LSI for calculator with 10 digits, 67 functions, 3 expression and hexadecimal, octal and binary, statistic calculation, fractional number calculation, and logic operation with the following features.

### FEATURES

- 12-digit display plus 2 digits code at the right margin.

- Scientific and engineering display.

Mantissa 10 digits plus exponent 2 digits plus negative code 2 digits.

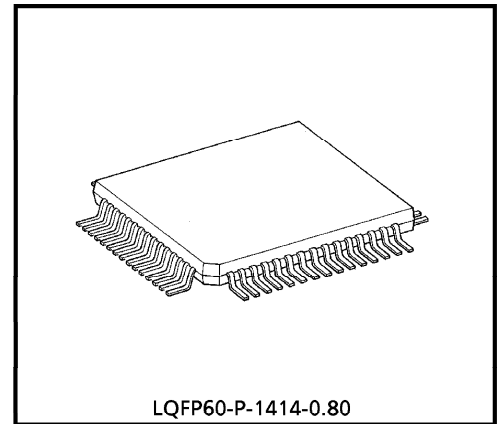
- Other than above

Mantissa 10 digits plus negative code 1 digit.

- 13 kinds of special display

M	Memory	HEX	Hexadecimal mode
-	Mantissa and exponent Minus	SD	Statistic calculation mode
E	Error	DEG	Degree
INV	Inverse	RAD	Radian
HYP	Hyperbolic	GRAD	Gradian
BIN	Binary mode	( )	Parenthesis calculation
OCT	Octal mode		

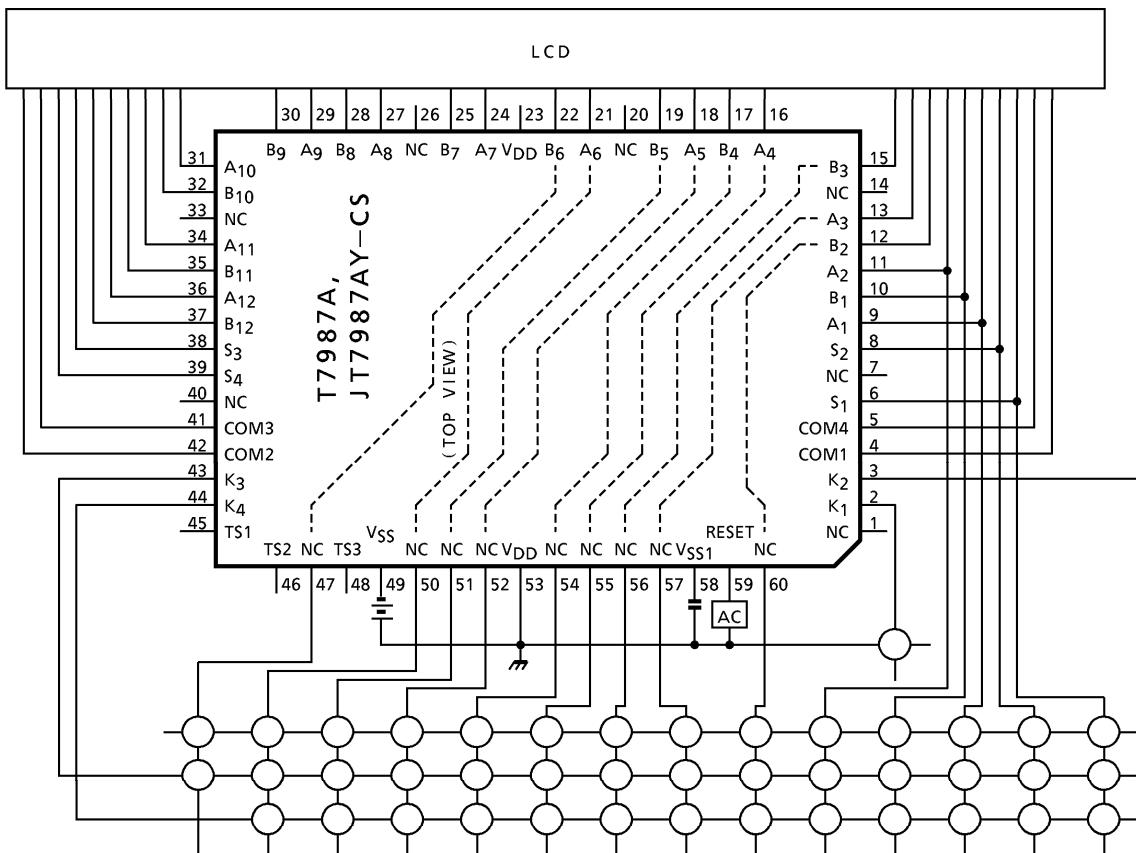
- The minus sign of the mantissa is floating minus.
- The arithmetic key operation in clouding  $Y^X$  or  $\sqrt[X]{Y}$  has same sequence as mathematical equation. 6 pending operations are allowed and ( ) are up to continuous 15 levels.
- Fractional number calculation.
- Statistic calculation includes 3 kinds of the normal distribution, total 9 kinds.
- It is possible to convert mutually between decimal, binary, octal and hexadecimal, and the four operations in arithmetic in binary, octal and hexadecimal.
- One independent accumulating memory.



Weight : 0.66g (Typ.)

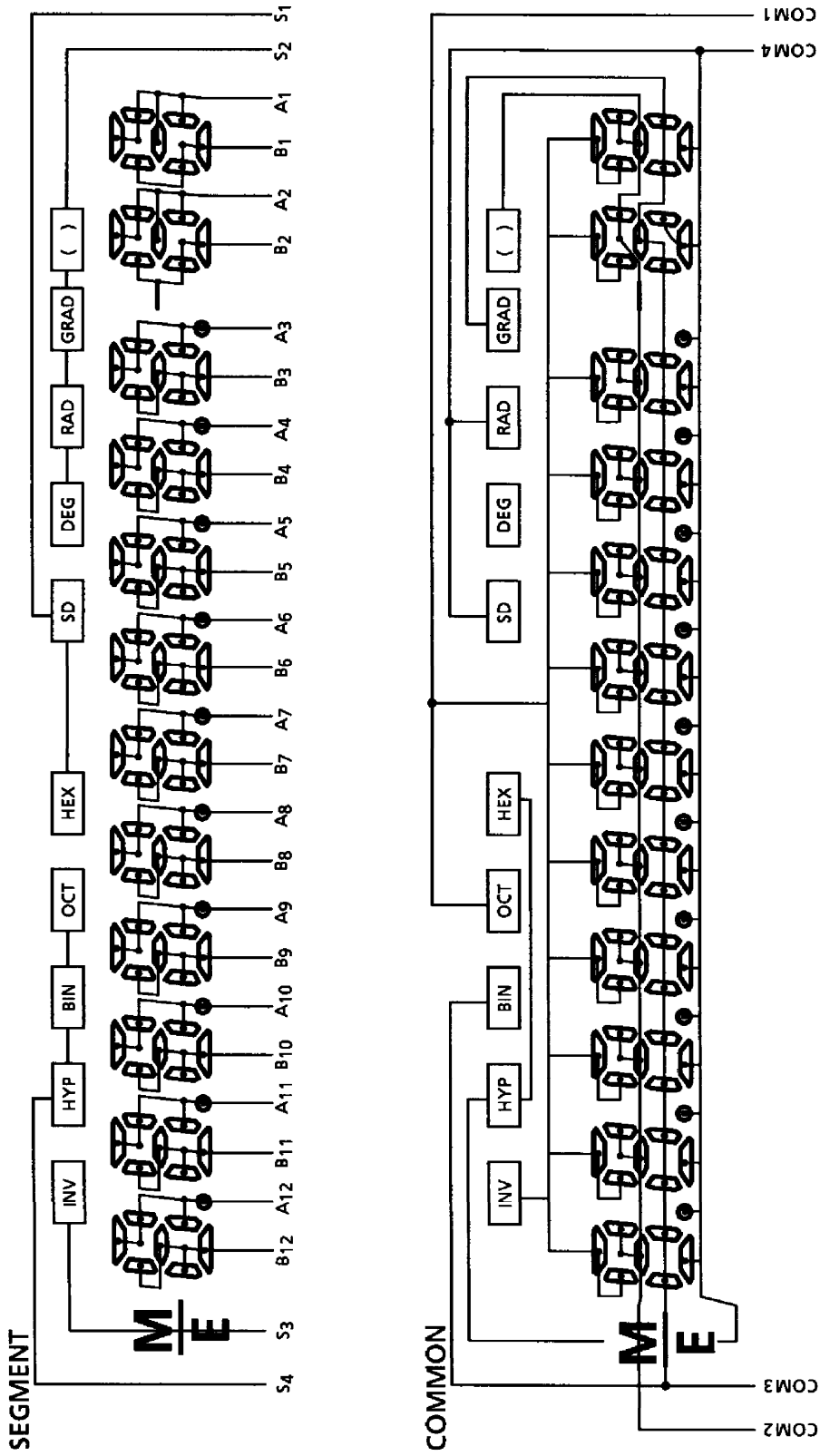
- It is possible to convert or fix the display number system by FLO (Floating) , SCI (Scientific) or ENG (Engineering) key.
- It is possible to specify decimal part digits (0~9) by FIX key.
- Direct drive for FEM LCD (1/3 prebias, 1/4 duty) .
- Automatic power on clear.
- Low-power consumption.  $V_{SS} = -3.0V$  single power supply.
- The 60-pin flat package is used.

**SYSTEM BLOCK DIAGRAM**

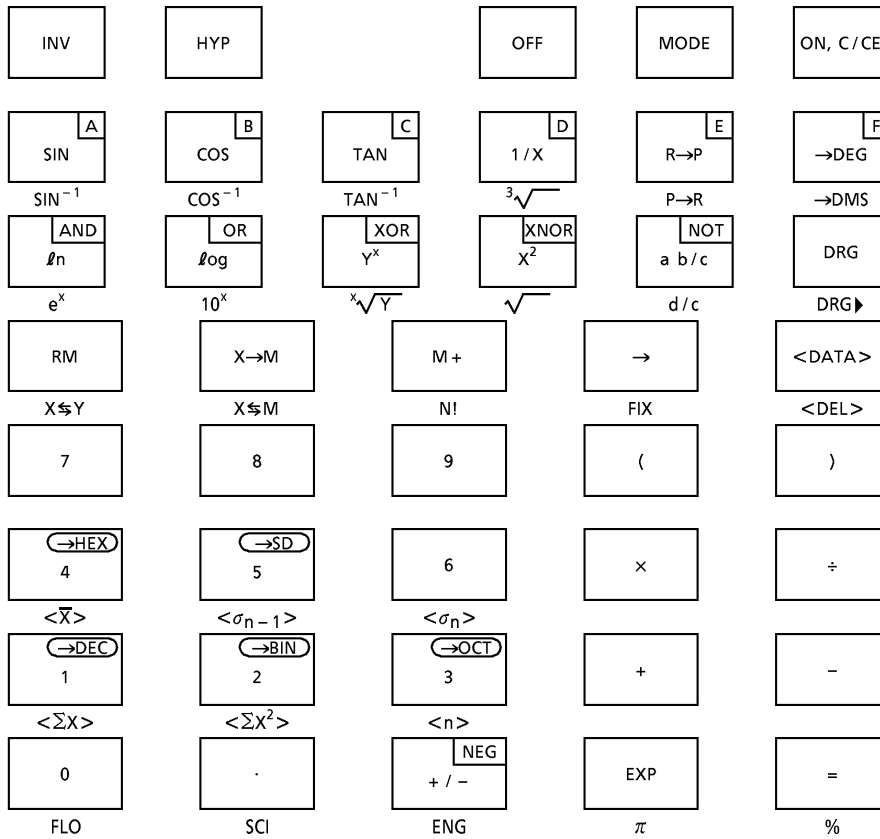


(Note) Input capacity  $\leq 400$  (pF) at  $V_{SS} = -3.0$  (V)  
 Key resistance  $\leq 3.0$  (k $\Omega$ ) at  $V_{SS} = -3.0$  (V)

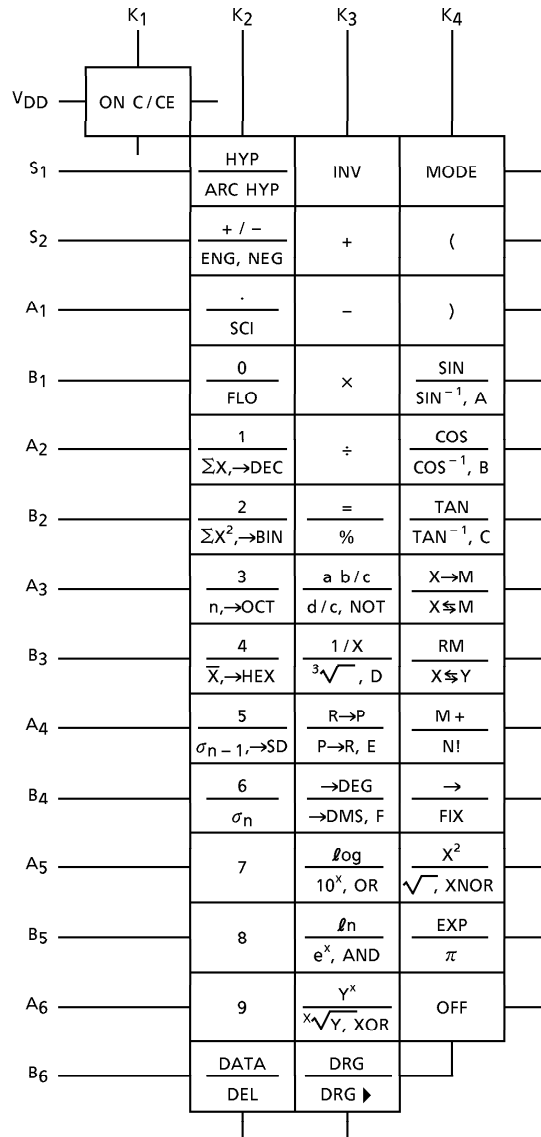
CONNECTION OF LCD



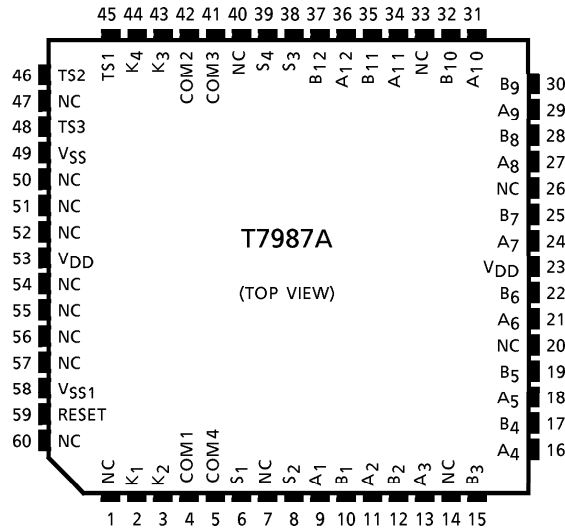
SET KEY LAYOUT (Example)



**KEY CONNECTION**



**PIN ASSIGNMENT**



**SPECIFICATION OF CALCULATOR**

Speed of calculation

Key on 4.8ms

Key off 34.4ms

$f\phi_{WAIT} = 15\text{kHz}$ ,  $f\phi_{op} = 80\text{kHz}$

The calculation speed doesn't include the key on or off time.

ITEM	OPERATION			CALCULATION SPEED (ms)
Number	DEC		5	8
			5	8
	HEX		A	9
			A	9
Function	DEC		5 +	20
			5 ×	21
	HEX		A -	51
			A ÷	52
4 operation	DEC		1 + 2	29
			1 0 0 0 0 0 0 0 0 - 1	31
			5 × 9	31
			5 5 5 5 5 × 9 9 9 9	36
			5 ÷ 9	47
			5 5 5 5 5 ÷ 9 9 9 9	58
	HEX		A B C + D E F	88
			A B C - D E F	144
$Y^X, X\sqrt{Y}$		A B C × D E F	100	
		A B C ÷ D E F	98	
$Y^X, X\sqrt{Y}$		3 Y <sup>x</sup> 4 =	252	
		3 <sup>x</sup> √Y 4 =	262	

ITEM	OPERATION			CALCULATION SPEED (ms)	
SIN	DEG		3 0	SIN	241
	RAD		$\pi \div 6 =$	SIN	231
	GRAD		1 0 0 $\div 3 =$	SIN	350
COS	DEG		6 0	COS	244
	RAD		$\pi \div 3 =$	COS	311
	GRAD		2 0 0 $\div 3 =$	COS	354
TAN	DEG		4 5	TAN	118
	RAD		$\pi \div 4 =$	TAN	45
	GRAD		5 0	TAN	48
SIN <sup>-1</sup>	DEG		0. 5	SIN <sup>-1</sup>	252
	RAD		0. 5	SIN <sup>-1</sup>	198
	GRAD		0. 5	SIN <sup>-1</sup>	249
COS <sup>-1</sup>	DEG		0. 5	COS <sup>-1</sup>	322
	RAD		0. 5	COS <sup>-1</sup>	230
	GRAD		0. 5	COS <sup>-1</sup>	319
TAN <sup>-1</sup>	DEG		1	TAN <sup>-1</sup>	73
	RAD		1	TAN <sup>-1</sup>	46
	GRAD		1	TAN <sup>-1</sup>	72
Ln			2 0	ln	47
Log			2 0	log	99
e <sup>x</sup>			2 0	e <sup>x</sup>	94
10 <sup>x</sup>			1. 2 3	10 <sup>x</sup>	113
			1 0	10 <sup>x</sup>	40
X!			6 9	N!	291
HYP			3 hyp	SIN	189
			3 hyp	COS	190
			3 hyp	TAN	232
ARC HYP			3 hyp <sup>-1</sup>	SIN	184
			3 hyp <sup>-1</sup>	COS	205
			0.5 hyp <sup>-1</sup>	TAN	174
X <sup>2</sup>			2 0	X <sup>2</sup>	18
$\sqrt{\quad}$			2 0	$\sqrt{\quad}$	64
1/X			2 0	1/X	23
$\sqrt[3]{\quad}$			2 0	$\sqrt[3]{\quad}$	180
Mutual Conversion	DEC		1 2 3	→BIN	35
			1 2 3 4 5	→OCT	40
			1 2 3 4 5	→HEX	35
	BIN		1 0 1 0 1	→DEC	27
	OCT		1 2 3 4 5	→DEC	33
	HEX		A B C D E	→DEC	54
→DEG			1.2 3 4 5	→DEG	78
→DMS			1.2 3 4 5	→DMS	87

ITEM	OPERATION				CALCULATION SPEED (ms)	
R→P	DEG	$\sqrt[3]{X \leftrightarrow Y}$ 1			R→P	275
	RAD	$\sqrt[3]{X \leftrightarrow Y}$ 1			R→P	216
	GRAD	$\sqrt[3]{X \leftrightarrow Y}$ 1			R→P	274
P→R	DEG	2 $X \leftrightarrow Y$ 3 0			P→R	462
	RAD	2	$X \leftrightarrow Y$	30 DRG▶	P→R	437
	GRAD	2	$X \leftrightarrow Y$	30 DRG▶ DRG▶	P→R	626
→RAD	DEG	3 6 0			DRG▶	43
→GRAD	RAD	2 $\times \pi =$			DRG▶	29
→DEG	GRAD	4 0 0			DRG▶	20
Memory	1 2 3				X→M	17
	1 2 3 X → M				M +	19
	1 2 3 X → M				RM	12
	1 2 3 X → M				X↔M	19
%	1 2 3 + 4 5 6				%	26
	1 2 3 - 4 5 6				%	26
	1 2 3 $\times$ 4 5 6				%	17
	1 2 3 $\div$ 4 5 6				%	17
Exchange	1 2 3 + 4 5 6				X↔Y	15
Shift	1 2 3				→	8
Statistic Calculation	1 DATA 2 DATA 3 DATA ..... 8 DATA 9				DATA	38
	The above-mentioned data				n	16
					$\bar{X}$	21
					$\Sigma X$	15
					$\Sigma X^2$	15
					$\sigma_{n-1}$	90
					$\sigma_n$	104
Logic operation	HEX	A B C		AND D E F	=	181
		A B C		OR D E F	=	195
		A B C		XOR D E F	=	171
		A B C		XNOR D E F	=	289
		A B C			NOT	118
NEG	HEX	A B C			NEG	112
Fractional number calculation	Function	2 ab/c 3 6 ab/c 2 3 4			-	75
		2 ab/c 3 6 ab/c 2 3 4			÷	76
	4-operation	2 $\_$ 36J 234 + 3 $\_$ 45 J 345			=	161
		2 $\_$ 36J 234 - 3 $\_$ 45 J 345			=	153
		2 $\_$ 36J 234 $\times$ 3 $\_$ 45 J 345			=	149
2 $\_$ 36J 234 $\div$ 3 $\_$ 45 J 345			=	168		



**OPERATION RANGE AND ACCURACY**

FUNCTION	ANGLE UNIT	OPERATION RANGE	UNDER FLOW AREA	NORMAL ACCURACY
SIN X	DEG	$0 \leq  X  \leq 4.499999999 \times 10^{10}$	$0 \leq  X  \leq 5.729577951 \times 10^{-98}$	± 1 in 10th significant digit
	RAD	$0 \leq  X  \leq 785398163.3$	—	
	GRAD	$0 \leq  X  \leq 4.999999999 \times 10^{10}$	$0 \leq  X  \leq 6.366197723 \times 10^{-98}$	
COS X	DEG	$0 \leq  X  \leq 4.500000008 \times 10^{10}$	—	
	RAD	$0 \leq  X  \leq 785398164.9$	—	
	GRAD	$0 \leq  X  \leq 5.000000009 \times 10^{10}$	—	
TAN X	DEG	SAME AS SIN X except for $ X  = (2n - 1) \cdot 90$	SAME AS SIN X	
	RAD	SAME AS SIN X except for $ X  = (2n - 1) \cdot \pi / 2$	SAME AS SIN X	
	GRAD	SAME AS SIN X except for $ X  = (2n - 1) \cdot 100$	SAME AS SIN X	
SIN <sup>-1</sup> X	DEG	$0 \leq  X  \leq 1$	$0 \leq  X  \leq 1.570796326 \times 10^{-99}$	
	RAD	$0 \leq  X  \leq 1$	—	
	GRAD	$0 \leq  X  \leq 1$	$0 \leq  X  \leq 1.570796326 \times 10^{-99}$	
COS <sup>-1</sup> X	DEG	SAME AS SIN <sup>-1</sup> X	—	
	RAD	SAME AS SIN <sup>-1</sup> X	—	
	GRAD	SAME AS SIN <sup>-1</sup> X	—	
TAN <sup>-1</sup> X	DEG	$0 \leq  X  \leq 9.999999999 \times 10^{99}$	SAME AS SIN <sup>-1</sup> X	
	RAD	$0 \leq  X  \leq 9.999999999 \times 10^{99}$	—	
	GRAD	$0 \leq  X  \leq 9.999999999 \times 10^{99}$	SAME AS SIN <sup>-1</sup> X	
LN X		$0 < X$	—	
LOG X		$0 < X$	—	
e <sup>X</sup>		$-9.999999999 \times 10^{99}$ $\leq X \leq 230.2585092$	$-9.999999999 \times 10^{99}$ $\leq X \leq -227.9559243$	
10 <sup>X</sup>		$-9.999999999 \times 10^{99}$ $\leq X \leq 99.99999999$	$-9.999999999 \times 10^{99}$ $\leq X \leq -99.00000001$	
X!		$0 \leq X \leq 69$ (INTEGER)	—	
$\frac{1}{X}$		$1 \times 10^{-99}$ $\leq  X  \leq 9.999999999 \times 10^{99}$	$1.000000001 \times 10^{99}$ $\leq  X  \leq 9.999999999 \times 10^{99}$	
X <sup>2</sup>		$0 \leq  X  \leq 9.999999999 \times 10^{49}$	$0 \leq  X  \leq 3.162277660 \times 10^{-50}$	
$\sqrt{X}$		$0 \leq X \leq 9.999999999 \times 10^{99}$	—	
$\sqrt[3]{X}$		$0 \leq  X  \leq 9.999999999 \times 10^{99}$	—	
DMS→DEG		$0 \leq  X  \leq 9.999999999 \times 10^9$	—	
DEG→DMS		$0 \leq  X  \leq 9999999.999$	$0 \leq  X  \leq 1.388888888 \times 10^{-6}$	± 1 in least significant digit

FUNCTION	OPERATION RANGE	UNDER FLOW AREA	NORMAL ACCURACY
SINH X	$0 \leq  X  \leq 230.2585092$	—	± 1 in 10th significant digit
COSH X	$0 \leq  X  \leq 230.2585092$	—	
TANH X	$0 \leq  X  \leq 9.999999999 \times 10^{99}$	—	
SINH <sup>-1</sup> X	$0 \leq  X  \leq 4.999999999 \times 10^{99}$	—	
COSH <sup>-1</sup> X	$1 \leq X \leq 4.999999999 \times 10^{99}$	—	
TANH <sup>-1</sup> X	$0 \leq  X  \leq 9.999999999 \times 10^{-1}$	—	
R→P (xy→γθ)	$ x ,  y  \leq 9.999999999 \times 10^{49}$ $(x^2 + y^2) \leq 9.999999999 \times 10^{99}$ $\frac{Y}{X}$ ; SAME AS TAN <sup>-1</sup> X	$\frac{Y}{X}$ ; SAME AS TAN <sup>-1</sup> X	
P→R (γθ→xy)	$0 \leq \gamma \leq 9.999999999 \times 10^{99}$ $\theta$ ; SAME AS SIN X, COS X	$\theta$ ; SAME AS SIN X, COS X	
DEG→RAD	$0 \leq  X  \leq 9.999999999 \times 10^{99}$	$0 \leq  X  \leq 5.729577951 \times 10^{-98}$	
RAD→GRAD	$0 \leq  X  \leq 1.570796326 \times 10^{98}$	—	
GRAD→DEG	$0 \leq  X  \leq 9.999999999 \times 10^{99}$	$0 \leq  X  \leq 1.111111111 \times 10^{-99}$	
Y <sup>X</sup>	$-9.999999999 \times 10^{99}$ $\leq X \cdot \text{LN }  Y  \leq 230.2585092$  (1) Y>0…The above-mentioned operation range. (2) Y<0…X (Integer) or, 1/X (Odd, X≠0) …The above-mentioned operation range. (3) Y=0…0<X	$-9.999999999 \times 10^{99}$ $\leq X \cdot \text{LN }  Y  \leq -227.9559243$	± 1 in 10th significant digit
<sup>X</sup> √Y	$-9.999999999 \times 10^{99}$ $\leq \frac{1}{X} \cdot \text{LN }  Y  \leq 230.2585092$  (1) Y>0…The above-mentioned operation range. (2) Y<0…X (Odd) or 1/X (Integer, X≠0) …The above-mentioned operation range. (3) Y=0…0<X	$-9.999999999 \times 10^{99}$ $\leq \frac{1}{X} \cdot \text{LN }  Y  \leq -227.95593243$	± 1 in 10th significant digit
→DEC	<b>Operation range</b> The following operation range after the conversion. $0 \leq  X  \leq 9999999999$		—
→BIN	The following operation range after the conversion. $1000000000 \leq X \leq 1111111111$ $0 \leq X \leq 1111111111$		—
→OCT	The following operation range after the conversion. $4000000000 \leq X \leq 7777777777$ $0 \leq X \leq 3777777777$		—
→HEX	The following operation range after the conversion. FDABF41CO1 ≤ X ≤ FFFFFFFF $0 \leq X \leq 2540BE3FF$		—

FUNCTION		OPERATION RANGE	NORMAL ACCURACY
AND		BIN ; 1000000000 ≤ X ≤ 1111111111 0 ≤ X ≤ 1111111111	—
OR		OCT ; 4000000000 ≤ X ≤ 7777777777 0 ≤ X ≤ 3777777777	
XOR		HEX ; The following operation range after the operation.	
XNOR		FDABF41CO1 ≤ X ≤ FFFFFFFF 0 ≤ X ≤ 2540BE3FF	
NOT		BIN ; SAME AS AND OCT ; SAME AS AND HEX ; FDABF41CO1 ≤ X ≤ FFFFFFFF 0 ≤ X ≤ 2540BE3FE	—
NEG		BIN ; 1000000001 ≤ X ≤ 1111111111 0 ≤ X ≤ 1111111111 OCT ; 4000000001 ≤ X ≤ 7777777777 0 ≤ X ≤ 3777777777 HEX ; FDABF41CO1 ≤ X ≤ FFFFFFFF 0 ≤ X ≤ 2540BE3FF	—
Statistic	DATA	$ x  \leq 9.999999999 \times 10^{49}$	± 1 in 10th significant digit
	DEL	$ \sum x  \leq 9.999999999 \times 10^{99}$	
		$\sum x^2 \leq 9.999999999 \times 10^{99}$	
		$0 \leq n \leq 9999999999$ . n = Integer	
	$\bar{x}$	n ≠ 0	
	$\sigma_{n-1}$	n ≠ 1, n ≠ 0 $0 \leq \frac{\sum X^2 - \{(\sum X)^2 / n\}}{n-1} \leq 9.999999999 \times 10^{99}$	
	$\sigma_n$	n ≠ 0 $0 \leq \frac{\sum X^2 - \{(\sum X)^2 / n\}}{n} \leq 9.999999999 \times 10^{99}$	

**MAXIMUM RATINGS (Ta = 25°C)**

CHARACTERISTICS	SYMBOL	RATING	UNIT
Supply Voltage	V <sub>SS</sub>	+0.3 ~ -3.5	V
Input Voltage	V <sub>IN</sub>	+0.3 ~ V <sub>SS</sub> - 0.3	V
Operating Temperature	T <sub>opr</sub>	0 ~ 40	°C
Storage Temperature	T <sub>stg</sub>	-55 ~ 125	°C

ELECTRICAL CHARACTERISTICS ( $V_{SS} = -3.0 \pm 0.2V$ ,  $V_{DD} = 0V$ ,  $T_a = 25 \pm 1.5^\circ C$ )

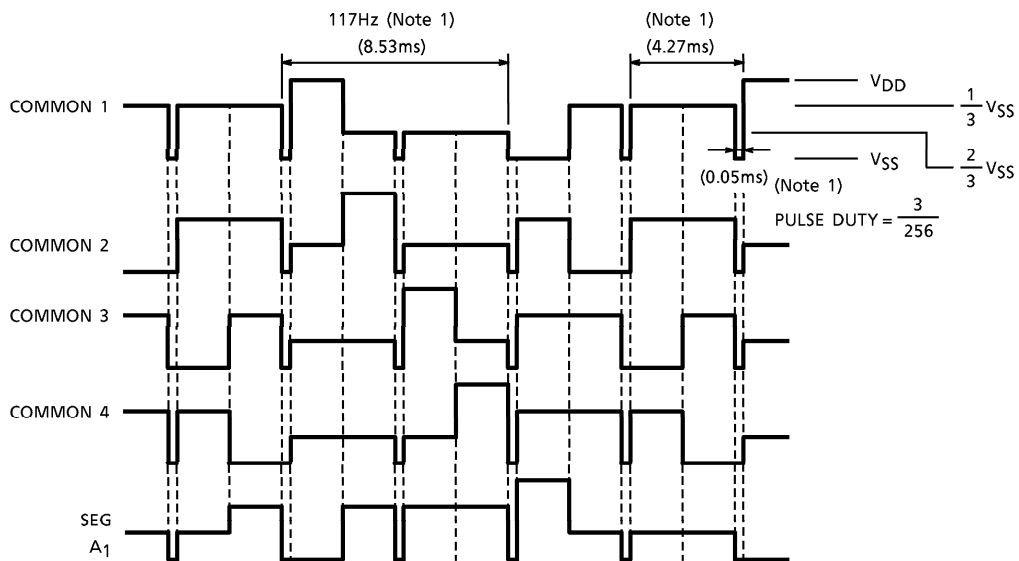
CHARACTERISTICS	SYMBOL	TEST CIRCUIT	PIN NAME	TEST CONDITION	MIN	TYP.	MAX	UNIT
Operating Voltage	—	—	—	—	-2.5	-3.0	-3.4	V
Supply Current	$I_{DD}$ WAIT	—	—	$V_{SS} = -3.0V$ , wait	—	20	35	$\mu A$
Supply Current	$I_{DD}$ OP	—	—	$V_{SS} = -3.0V$ , operate	—	70	120	$\mu A$
Supply Current	$I_{DD}$ OFF	—	—	$V_{SS} = -3.0V$ , off	—	1	3	$\mu A$
Oscillating Frequency	$F\phi$ WAIT	—	—	$V_{SS} = -3.0V$ , wait	9	15	21	kHz
Oscillating Frequency	$F\phi$ OP	—	—	$V_{SS} = -3.0V$ , operate	48	80	112	kHz
Fram Frequency	$f_F$	—	—	$V_{SS} = -3.0V$ , wait	70	117	164	Hz
Timer	T timer	—	—	$V_{SS} = -3.0V$	430	603	1005	s
"1" Input Voltage	$V_{IH}$	—	K1~K4 RESET	—	$V_{SS} + 0.5$	—	$V_{SS}$	V
"0" Input Voltage	$V_{IL}$	—	K1~K4 RESET	—	$V_{DD}$	—	-0.5	V
"1" Output Resistance	$R_{KEY}$	—	SEG	$V_{OUT} = V_{SS} + 0.5V$ : KEY STROBE	—	—	2	k $\Omega$
"0" Output Resistance	$R_{SEG}$ (L)	—	SEG	$V_{OUT} = V_{DD} - 0.5V$	—	—	90	k $\Omega$
"1" Output Resistance	$R_{SEG}$ (H)	—	SEG	$V_{OUT} = V_{SS} + 0.5V$ : KEY STROBE	—	—	90	k $\Omega$
"0" Output Resistance	$R_{COM}$ (L)	—	COM	$V_{OUT} = V_{DD} - 0.5V$	—	—	25	k $\Omega$
"1" Output Resistance	$R_{COM}$ (H)	—	COM	$V_{OUT} = V_{SS} + 0.5V$	—	—	25	k $\Omega$
KEY Pull Up Resistance	$R_{PULL}$ UP	—	K1	$V_{OUT} = 0V$ (Note 1)	27	45	63	k $\Omega$
KEY Pull Down Resistance	$R_{PULL}$ DOWN	—	K2~K4	$V_{OUT} = V_{SS}$ (Note 1)	27	45	63	k $\Omega$
KEY Pull Up Resistance	$R_{RESET}$ (H)	—	RESET	$V_{OUT} = 0V$	24	40	56	k $\Omega$
KEY Pull Down Resistance	$R_{RESET}$ (L)	—	RESET	$V_{OUT} = V_{DD} - 0.5V$	—	—	10	k $\Omega$
"M" Output Resistance	$R_{OM}$	—	SEG	$V_{OUT} = \frac{1}{3}V_{SS} - 0.5V$	—	125	—	k $\Omega$
"M" Output Resistance	$R_{OM}$	—	SEG	$V_{OUT} = \frac{2}{3}V_{SS} + 0.5V$	—	125	—	k $\Omega$
"M" Output Resistance	$R_{OM}$	—	COM	$V_{OUT} = \frac{1}{3}V_{SS} - 0.5V$	—	85	—	k $\Omega$
"M" Output Resistance	$R_{OM}$	—	COM	$V_{OUT} = \frac{2}{3}V_{SS} + 0.5V$	—	85	—	k $\Omega$
"1" Output Voltage	$V_{OH}$	—	RESET	—	$V_{SS} + 0.2$	$V_{SS}$	$V_{SS}$	V

CHARACTERISTICS	SYMBOL	TEST CIRCUIT	PIN NAME	TEST CONDITION	MIN	TYP.	MAX	UNIT
"0" Output Voltage	V <sub>OL</sub>	—	RESET	—	V <sub>DD</sub>	V <sub>DD</sub>	V <sub>DD</sub> - 0.2	V
"1" Output Voltage	V <sub>OH</sub>	—	K <sub>1</sub>	(Note 1)	V <sub>SS</sub> + 0.2	V <sub>SS</sub>	V <sub>SS</sub>	V
"0" Output Voltage	V <sub>OL</sub>	—	K <sub>2</sub> ~K <sub>4</sub>	(Note 1)	V <sub>DD</sub>	V <sub>DD</sub>	V <sub>DD</sub> - 0.2	V
"1" Output Voltage	V <sub>OH</sub>	—	SEG COM	—	V <sub>SS</sub> + 0.2	V <sub>SS</sub>	V <sub>SS</sub>	V
"M" Output Voltage	V <sub>OM</sub>	—	SEG COM	—	2/3 V <sub>SS</sub> + 0.2	2/3 V <sub>SS</sub>	2/3 V <sub>SS</sub> - 0.2	V
"M" Output Voltage	V <sub>OM</sub>	—	SEG COM	—	1/3 V <sub>SS</sub> + 0.2	1/3 V <sub>SS</sub>	1/3 V <sub>SS</sub> - 0.2	V
"0" Output Voltage	V <sub>OL</sub>	—	SEG COM	—	V <sub>DD</sub>	V <sub>DD</sub>	V <sub>DD</sub> - 0.2	V

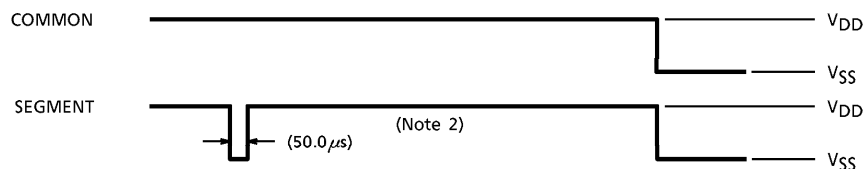
(Note 1) The key buffer is high impedance at keystroke.

**WAVEFORMS FOR DISPLAY**

Display



Key pulse output



(Note 1) F<sub>φ</sub>WAIT = 15kHz

(Note 2) F<sub>φ</sub>OP = 80kHz

PAD LOCATION TABLE

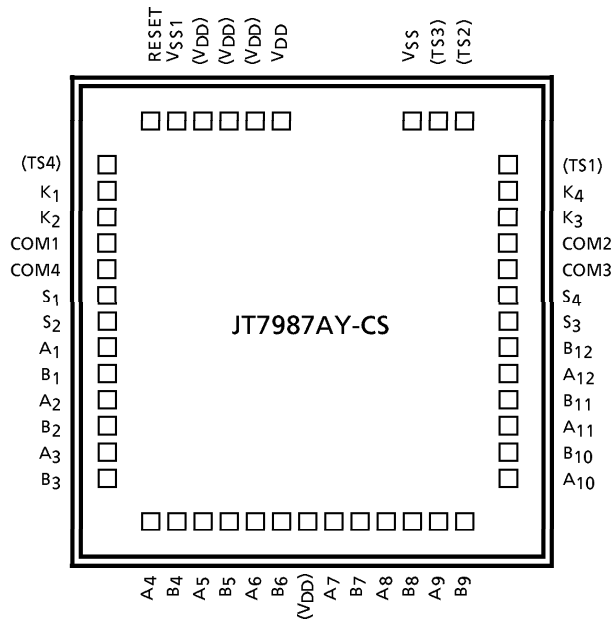
( $\mu\text{m}$ )

NAME	X POINT	Y POINT
RESET	- 890	1451
V <sub>SS1</sub>	- 731	1451
(V <sub>DD</sub> )	- 505	1451
(V <sub>DD</sub> )	- 346	1451
(V <sub>DD</sub> )	- 186	1451
V <sub>DD</sub>	8	1451
V <sub>SS</sub>	574	1451
(TS3)	734	1451
(TS2)	1055	1451
(TS1)	1270	993
K <sub>4</sub>	1270	829
K <sub>3</sub>	1270	666
COM2	1270	503
COM3	1270	339
S <sub>4</sub>	1270	175
S <sub>3</sub>	1270	13
B <sub>12</sub>	1270	- 149
A <sub>12</sub>	1270	- 315
B <sub>11</sub>	1270	- 478
A <sub>11</sub>	1270	- 641
B <sub>10</sub>	1270	- 805
A <sub>10</sub>	1270	- 968
B <sub>9</sub>	1076	- 1414
A <sub>9</sub>	888	- 1414

NAME	X POINT	Y POINT
B <sub>8</sub>	715	- 1414
A <sub>8</sub>	553	- 1414
B <sub>7</sub>	390	- 1414
A <sub>7</sub>	228	- 1414
(V <sub>DD</sub> )	0	- 1414
B <sub>6</sub>	- 231	- 1414
A <sub>6</sub>	- 393	- 1414
B <sub>5</sub>	- 555	- 1414
A <sub>5</sub>	- 717	- 1414
B <sub>4</sub>	- 879	- 1414
A <sub>4</sub>	- 1069	- 1414
B <sub>3</sub>	- 1270	- 958
A <sub>3</sub>	- 1270	- 795
B <sub>2</sub>	- 1270	- 631
A <sub>2</sub>	- 1270	- 468
B <sub>1</sub>	- 1270	- 304
A <sub>1</sub>	- 1270	- 141
S <sub>2</sub>	- 1270	23
S <sub>1</sub>	- 1270	186
COM4	- 1270	350
COM1	- 1270	513
K <sub>2</sub>	- 1270	676
K <sub>1</sub>	- 1270	840
(TS4)	- 1270	1003

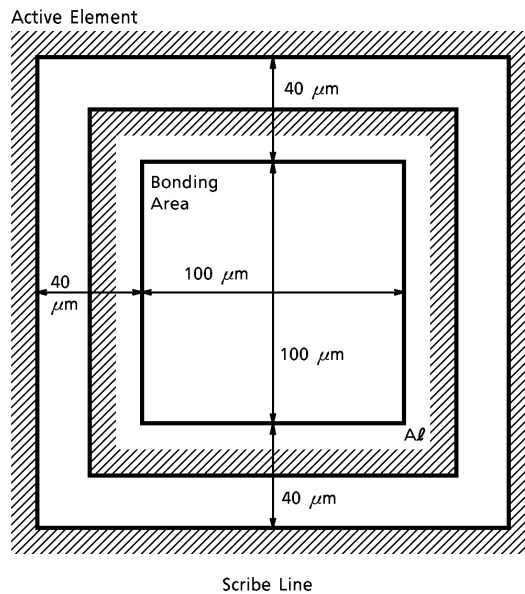
(Note) ( ) Do not connect.

**CHIP LAYOUT**



Chip size : 2.99 × 3.33 (mm)  
 Chip thickness : 200 ± 30 (μm)  
 Substrate : V<sub>DD</sub>

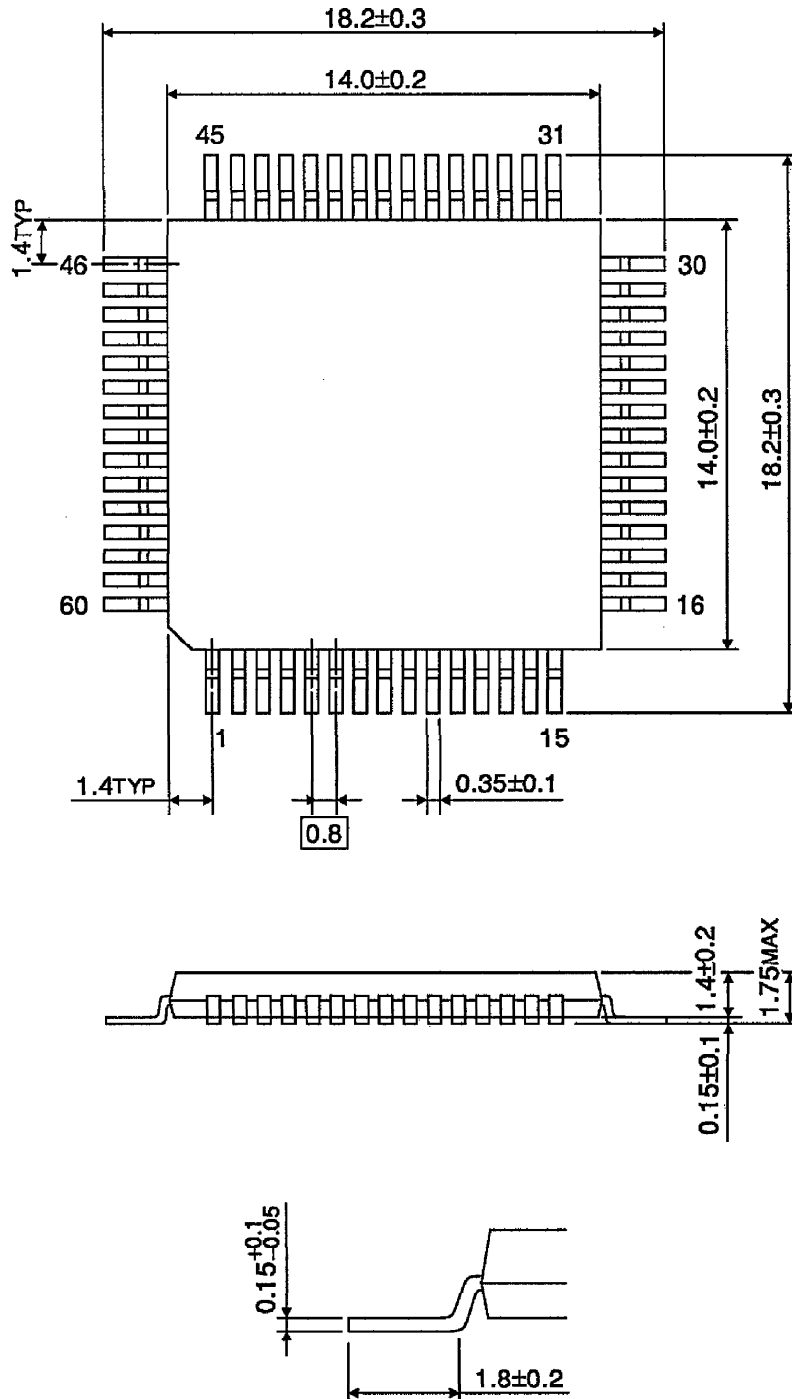
**PAD LAYOUT**



PAD Pitch 160 μm

**PACKAGE DIMENSIONS**  
LQFP60-P-1414-0.80

Unit : mm



Weight : 0.66g (Typ.)



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000707EBA

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